

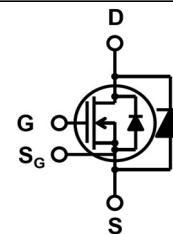
1200V SiC COPACK Power Module

V_{DS}	1200 V
$R_{DS,on}$	77 mΩ
$I_D (T_C=25°C)$	30 A
$T_{J,max}$	175°C

Features

- High speed switching SiC MOSFETs
- Freewheeling diode with zero reverse recovery SiC SBDS
- Simple to drive
- Kelvin reference for stable operation

Package



(1) S_G (Driver Source)
 (2) G (Gate)
 (3) D (Drain)
 (4) S (Source)

Benefits

- Low switching losses
- Low junction to case thermal resistance
- Very rugged and easy mount
- Direct mounting to heatsink (isolated package)

Part #	Package	Marking
GCMS080B120S1-E1	SOT-227	GCMS080B120S1-E1

Applications

- Photovoltaic Inverter
- Battery charger
- Server power supplies
- Energy storage system



Absolute Maximum Ratings

Characteristics	Symbol	Conditions	Values	Unit
Drain-Source Voltage	V_{rated}	$V_{GS}=0V, I_D=20\mu A$	1200	V
Continuous Drain Current	I_{DS}	$T_C=25°C, V_{GS}=20V$	30	A
		$T_C=100°C, V_{GS}=20V$	22	
	I_{SD}^*	$T_C=25°C, V_{GS}=20V$	39	
Schottky Diode DC Current	I_F	$T_C=25°C, V_{GS}=-5V$	32	
Pulsed Drain Current	$I_{DS,pulse}$	$T_C=25°C, V_{GS}=20V$	80	
Gate Source Voltage	V_{GSmax}		-10/25	V
	V_{GSop}	Recommended operational	-5/20	
Power Dissipation - MOSFET	P_{tot}	$T_C=25°C$	142	W
Operating & Storage Temperature	$T_J, T_{storage}$	Continuous	-55...175	°C

* I_{SD} maximum continuous current for parallel SBD and MOSFET body diode assuming maximum $R_{th,JC}$ of SBD

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Static Electrical Characteristics, at $T_J=25^\circ\text{C}$, unless otherwise specified

Characteristics	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=1\text{mA}$	1200	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=1200\text{V}, V_{\text{GS}}=0\text{V}$	-	1	20	μA
		$V_{\text{DS}}=1200\text{V}, V_{\text{GS}}=0\text{V}, T_J=175^\circ\text{C}$	-	28	300	
Gate-Source Leakage Current	$I_{\text{GSS+}}$	$V_{\text{GS}}=20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	100	nA
	$I_{\text{GSS-}}$	$V_{\text{GS}}=-5\text{V}, V_{\text{DS}}=0\text{V}$	-	-	-100	
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=10\text{mA}$	2	2.8	4	V
		$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=10\text{mA}, T_J=175^\circ\text{C}$	-	2.0	-	
Drain-Source On-Resistance	R_{DSon}	$V_{\text{GS}}=20\text{V}, I_{\text{D}}=20\text{A}$	-	77	100	$\text{m}\Omega$
		$V_{\text{GS}}=20\text{V}, I_{\text{D}}=10\text{A}$	-	71	90	
		$V_{\text{GS}}=20\text{V}, I_{\text{D}}=20\text{A}, T_J=125^\circ\text{C}$	-	106	-	
		$V_{\text{GS}}=20\text{V}, I_{\text{D}}=20\text{A}, T_J=175^\circ\text{C}$	-	134	-	
Transconductance	g_{fs}	$V_{\text{DS}}=20\text{V}, I_{\text{D}}=20\text{A}$	-	8.0	-	S
Internal Gate Resistance	$R_{\text{G(int)}}$	f=1MHz, $V_{\text{AC}}=25\text{mV}$, D-S Short	-	3.1	-	Ω

AC Electrical Characteristics, at $T_J=25^\circ\text{C}$, unless otherwise specified

Characteristics	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Input Capacitance	C_{ISS}	$V_{\text{GS}}=0\text{V}$ $V_{\text{DS}}=1000\text{V}$ $f=200\text{kHz}$ $V_{\text{AC}}=25\text{mV}$	-	1374	-	pF
Output Capacitance	$C_{\text{OSS}^{**}}$		-	103	-	
Reverse Transfer Capacitance	C_{RSS}		-	7	-	
Coss Stored Energy	$E_{\text{OSS}^{***}}$		-	63	-	μJ
Turn-On Switching Energy	E_{ON}	$V_{\text{DD}}=800\text{V}, I_{\text{DS}}=20\text{A}, R_{\text{G(ext)}}=2.5\Omega, V_{\text{GS}}=-5/+20\text{V}, L=975\mu\text{H}, \text{FWD}=GCMS080A120S1-E1$	-	183	-	μJ
Turn-Off Switching Energy	E_{OFF}		-	55	-	
Turn-On Delay Time	$t_{\text{D(on)}}$		-	9	-	
Rise Time	t_{R}		-	4	-	
Turn-Off Delay Time	$t_{\text{D(off)}}$		-	16	-	
Fall Time	t_{F}		-	14	-	
Total Gate Charge	Q_{G}		-	58	-	
Gate to Source Charge	Q_{GS}	$V_{\text{DD}}=800\text{V}, I_{\text{DS}}=20\text{A}$ $V_{\text{GS}}=-5/20\text{V}$	-	17	-	nC
Gate to Drain Charge	Q_{GD}		-	20	-	

** C_{OSS} is combination of MOSFET C_{OSS} and diode junction capacitance

*** E_{OSS} is calculated from C_{OSS} curve

Freewheeling Diode Characteristics, at $T_J=25^\circ\text{C}$, unless otherwise specified

Characteristics	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=-5\text{V}, I_{\text{S}}=10\text{A}$	-	1.50	1.7	V
		$V_{\text{GS}}=-5\text{V}, I_{\text{S}}=10\text{A}, T_J=175^\circ\text{C}$	-	2.10	-	
Reverse Recovery Time	t_{RR}	$I_{\text{S}}=20\text{A}, V_{\text{R}}=800\text{V}, V_{\text{GS}}=-5\text{V}$ di/dt=8.7A/ns	-	8	-	ns
Reverse Recovery Charge	Q_{RR}		-	172	-	
Peak Reverse Recovery Current	I_{RRM}		-	33	-	
Reverse Recovery Energy	E_{RR}		-	58	-	μJ

Thermal and Package Characteristics, at $T_J=25^\circ\text{C}$, unless otherwise specified

Characteristics	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal resistance, junction-case	R_{thJC}	MOSFET only	-	0.83	1.06	$^\circ\text{C}/\text{W}$
Thermal resistance, junction-case	R_{thJC}	Schottky diode only	-	1.09	1.38	
Mounting torque	M_d	M4-0.7 screws	1.1	-	1.5	$\text{N}\cdot\text{m}$
Terminal connection torque	M_{dt}	M4-0.7 screws	-	1.1	1.3	
Package weight	W_t		-	32	-	g
Isolation voltage	V_{ISOL}	$I_{ISOL} < 1\text{mA}$, 50/60 Hz, 1 min	2500	-	-	V

Typical Performance

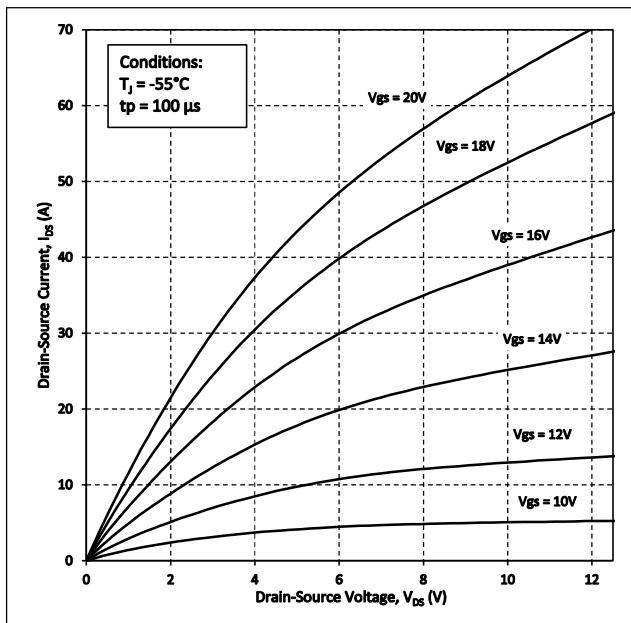


Figure 1. Output Characteristics $T_J = -55^\circ\text{C}$

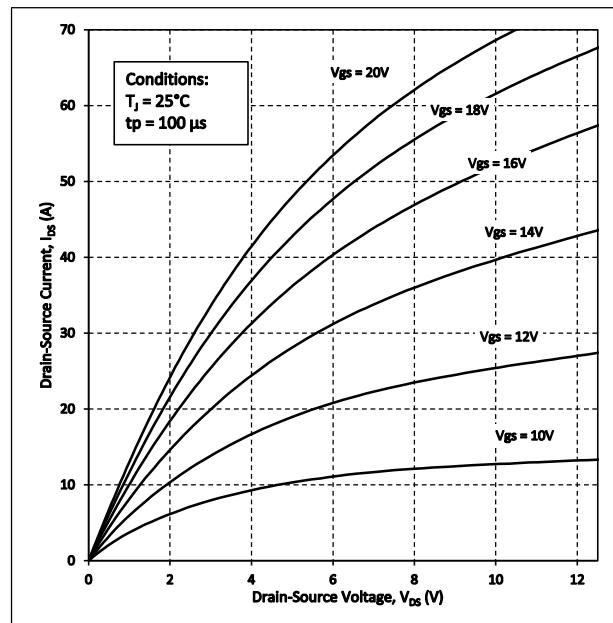


Figure 2. Output Characteristics $T_J = 25^\circ\text{C}$

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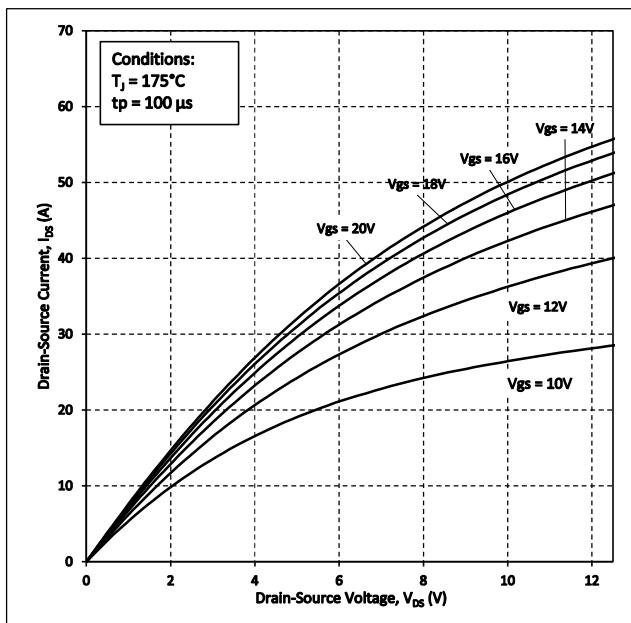


Figure 3. Output Characteristics $T_J = 175^\circ\text{C}$

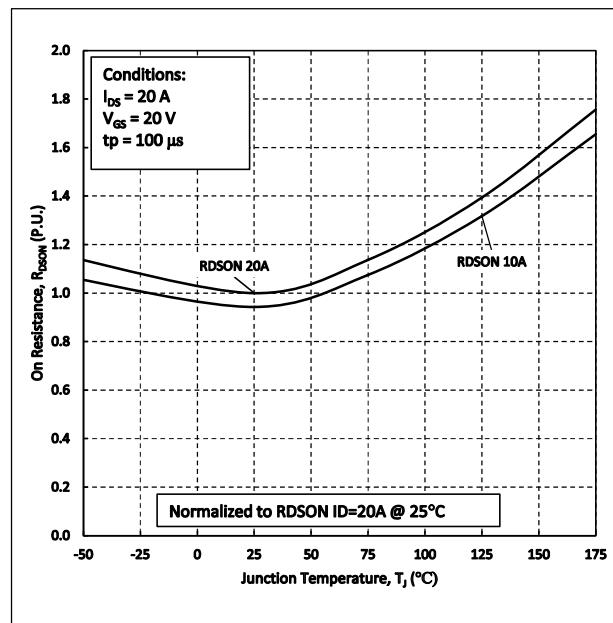


Figure 4. Normalized On-Resistance vs. Temperature

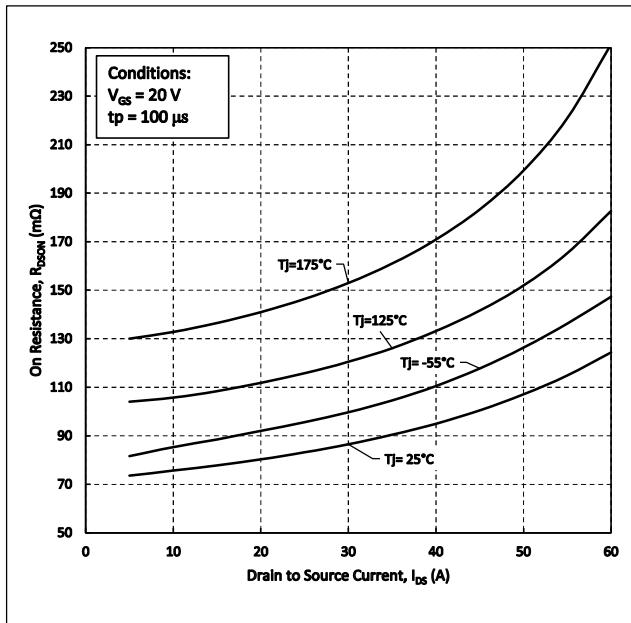
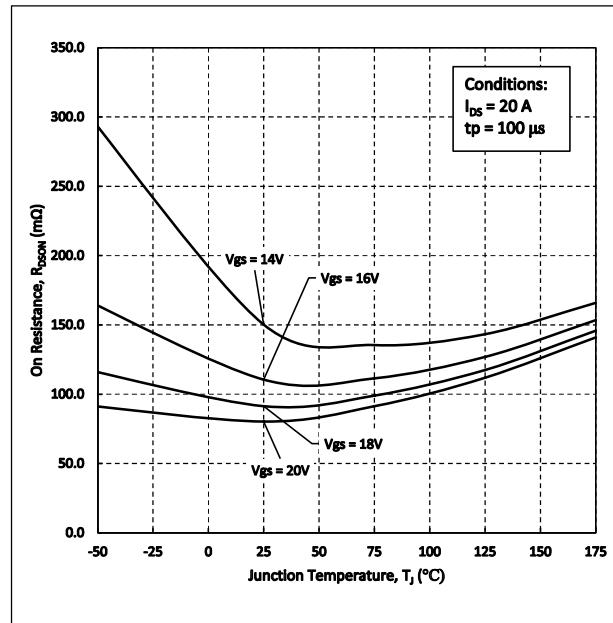


Figure 5. On-Resistance vs. Drain Current For Various Temperature



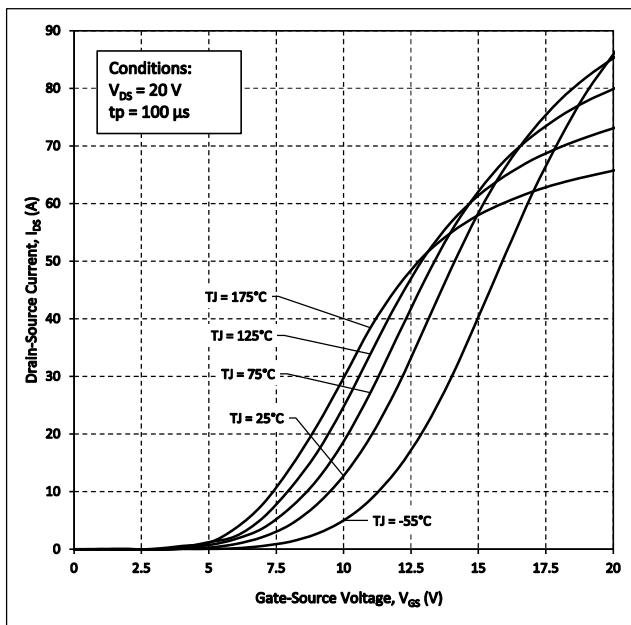


Figure 7. Transfer Characteristic for Various Junction Temperatures

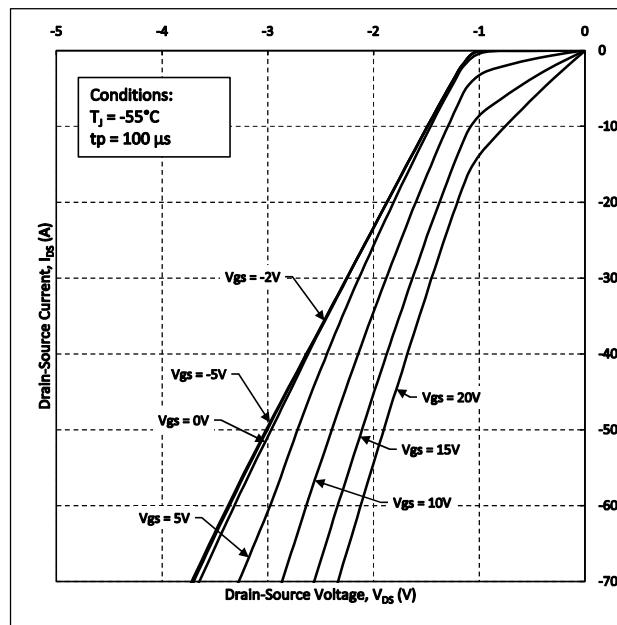


Figure 8. Freewheeling Diode Characteristics at $T_J = -55^\circ\text{C}$

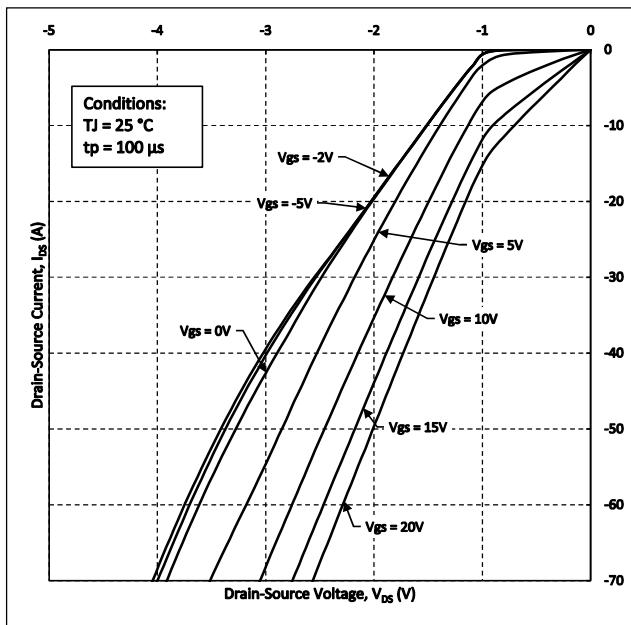


Figure 9. Freewheeling Diode Characteristics at $T_J = 25^\circ\text{C}$

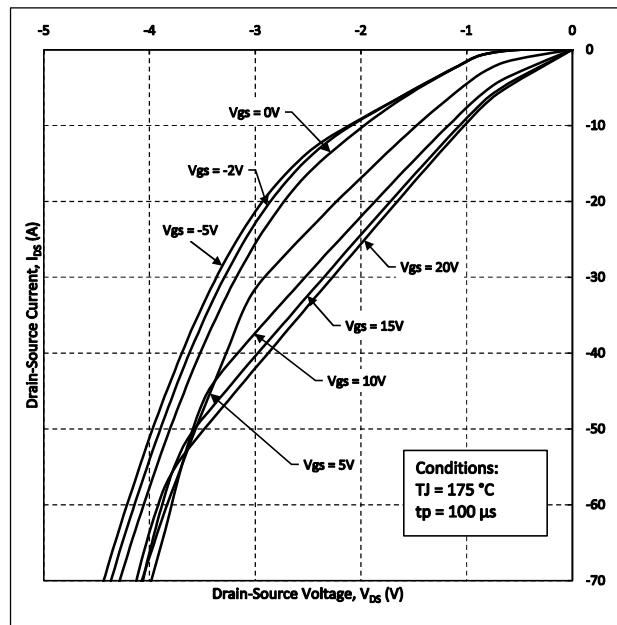
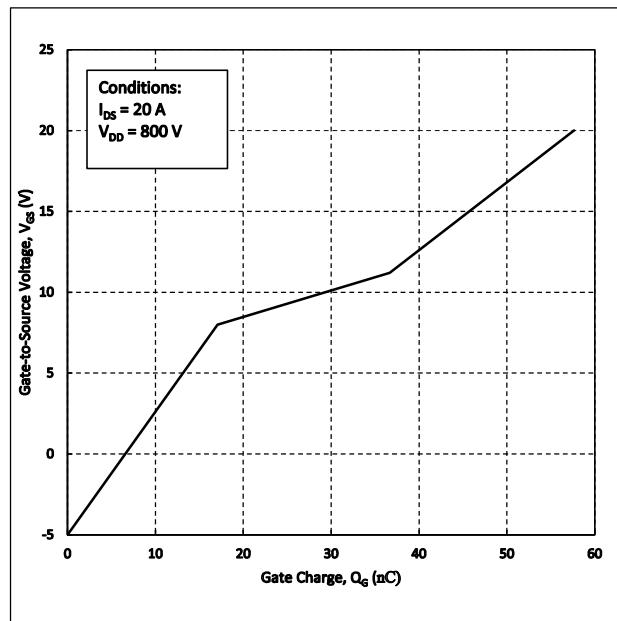
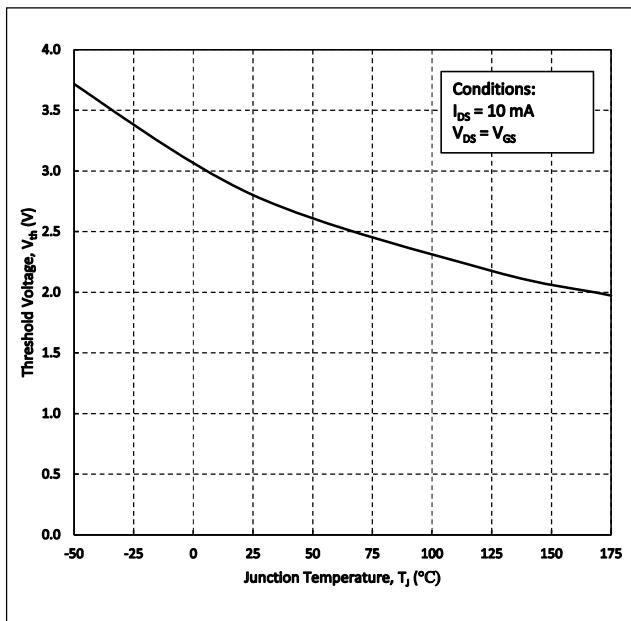
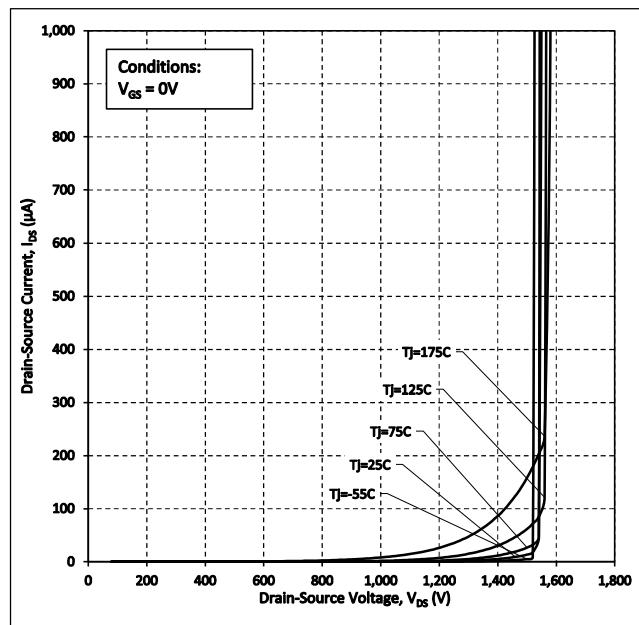
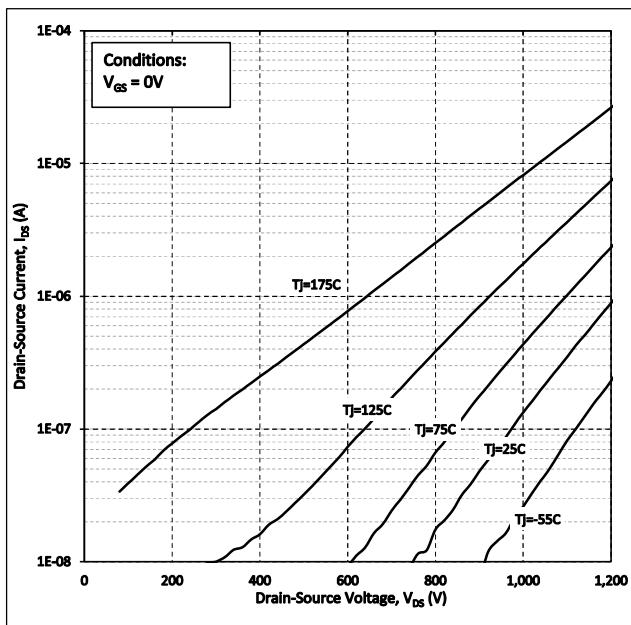


Figure 10. Freewheeling Diode Characteristics at $T_J = 175^\circ\text{C}$

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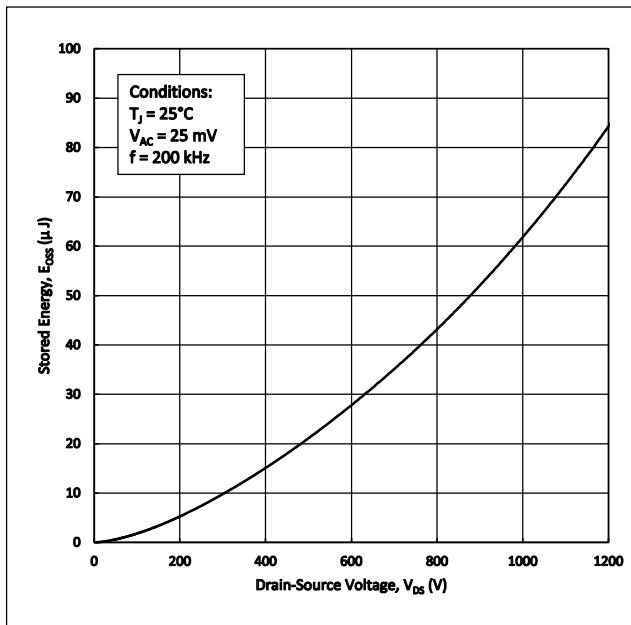


Figure 15. Output Capacitor Stored Energy

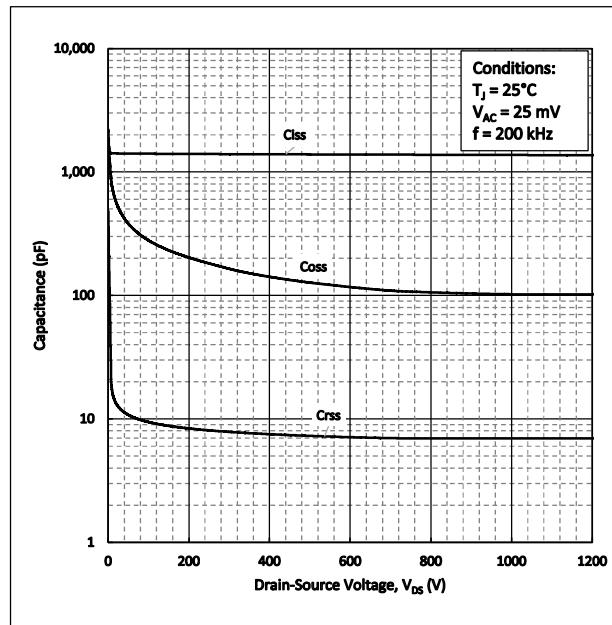


Figure 16. Capacitance vs Drain-Source Voltage

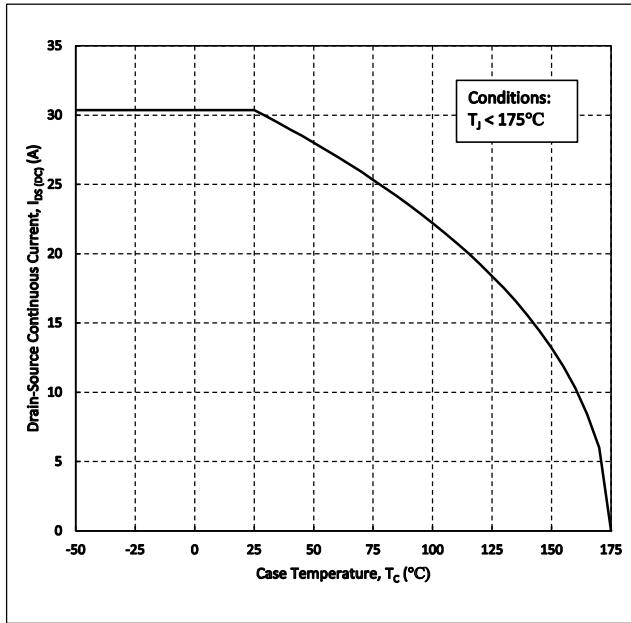


Figure 17. Continuous Drain Current Derating vs. Case Temperature

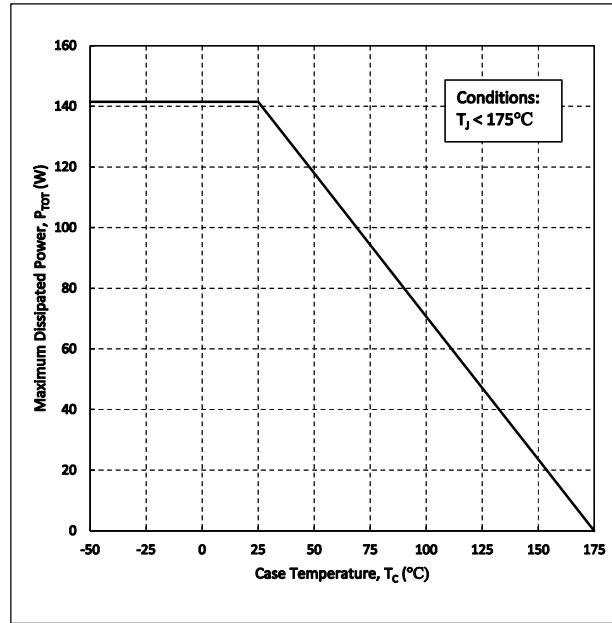


Figure 18. Maximum Power Dissipation Derating vs Case Temperature

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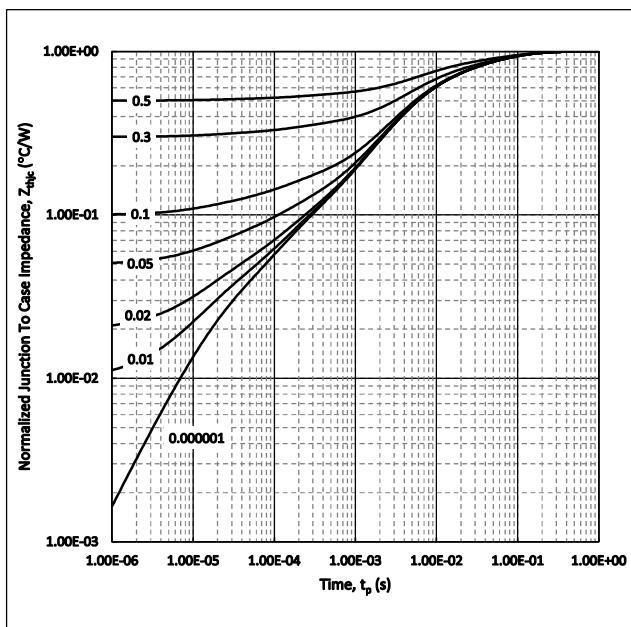


Figure 19. Transient Thermal impedance (Junction to Case)

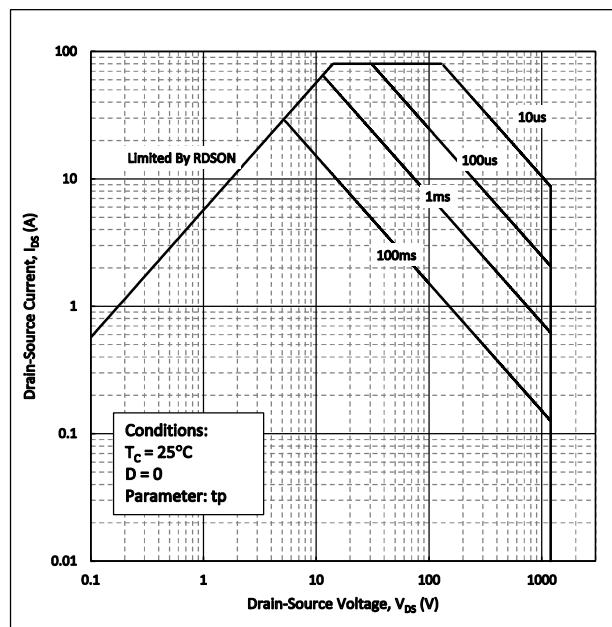


Figure 20. Safe Operating Area

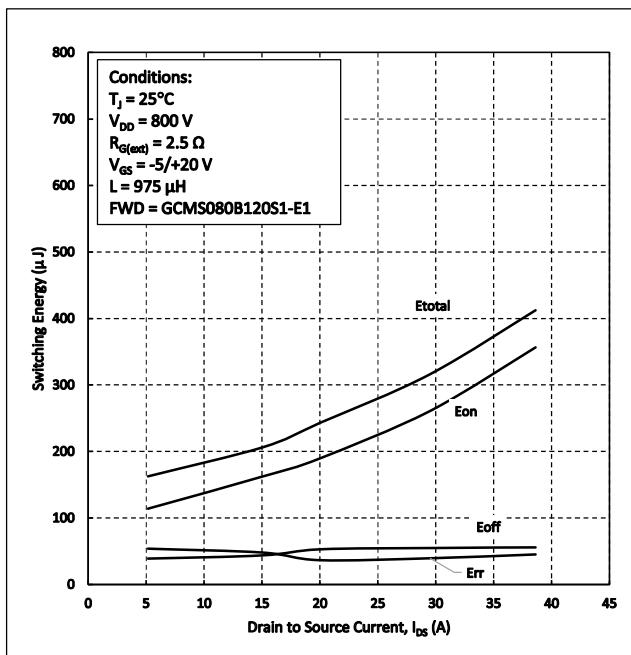


Figure 21. Clamped Inductive Switching Energy vs. Drain Current

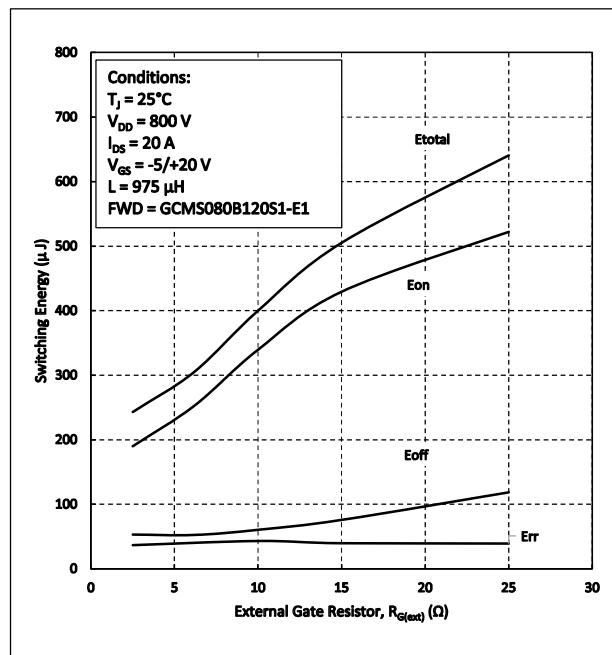


Figure 22. Clamped Inductive Switching Energy vs. $R_{G(\text{ext})}$

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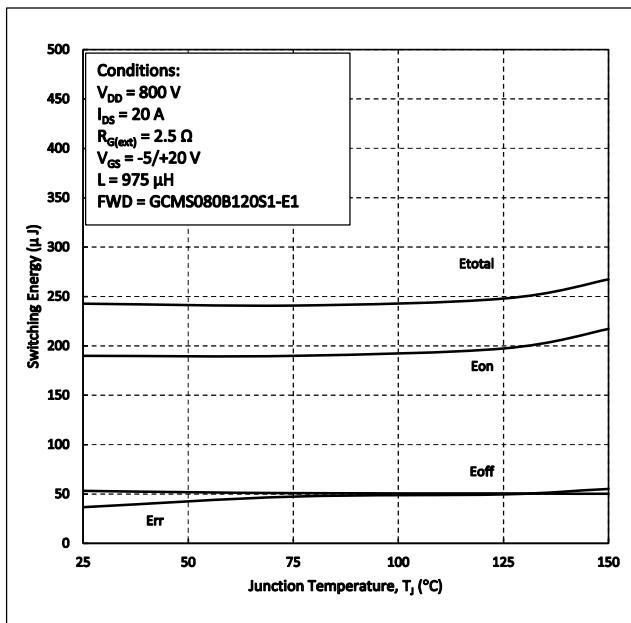


Figure 23. Clamped Inductive Switching Energy vs. Temperature

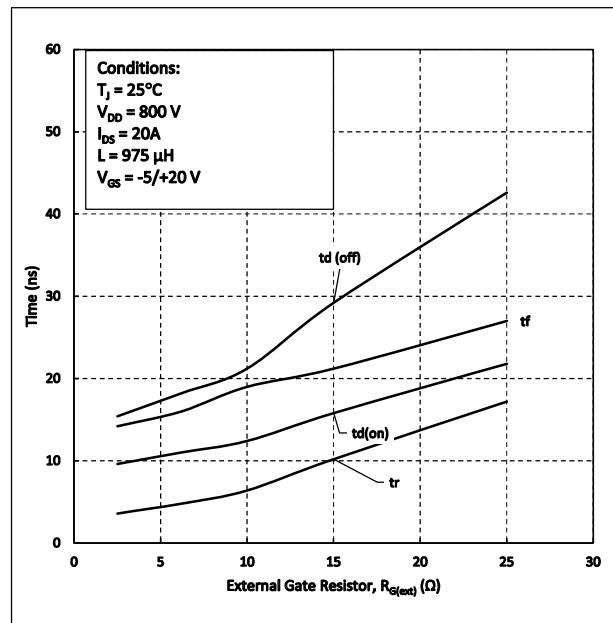


Figure 24. Switching Times vs $R_{G(ext)}$

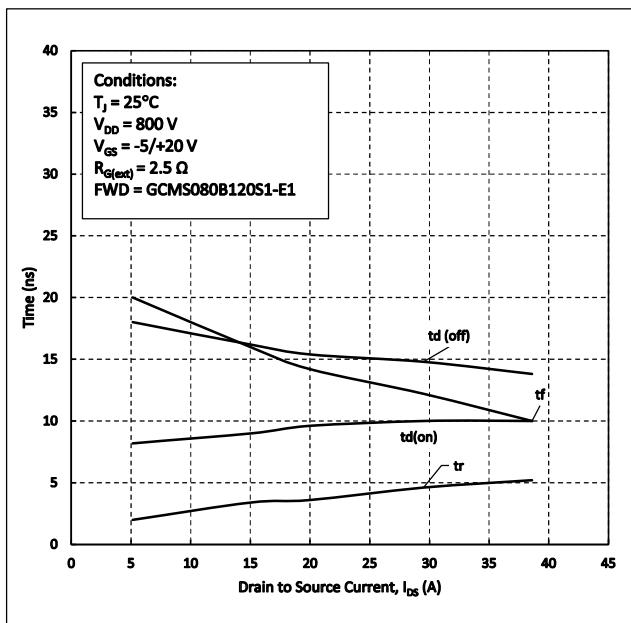


Figure 25. Switching Times vs. Drain Current

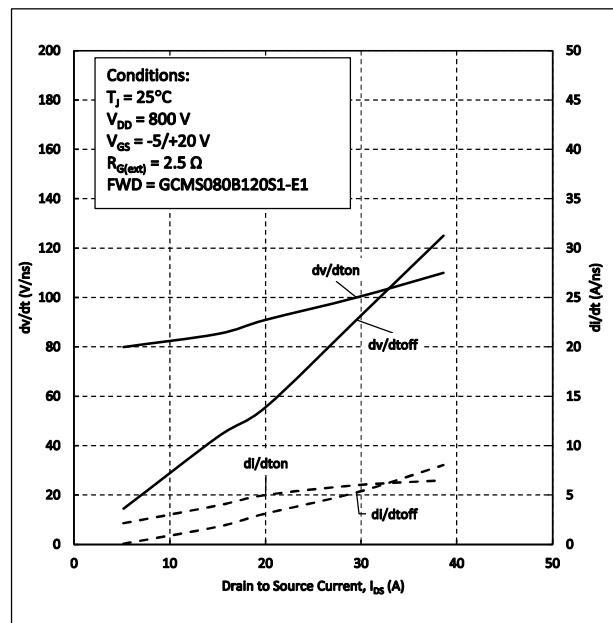
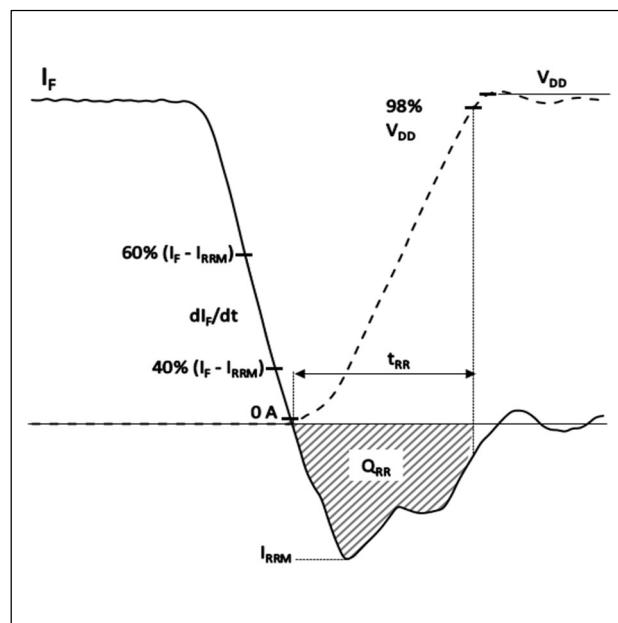
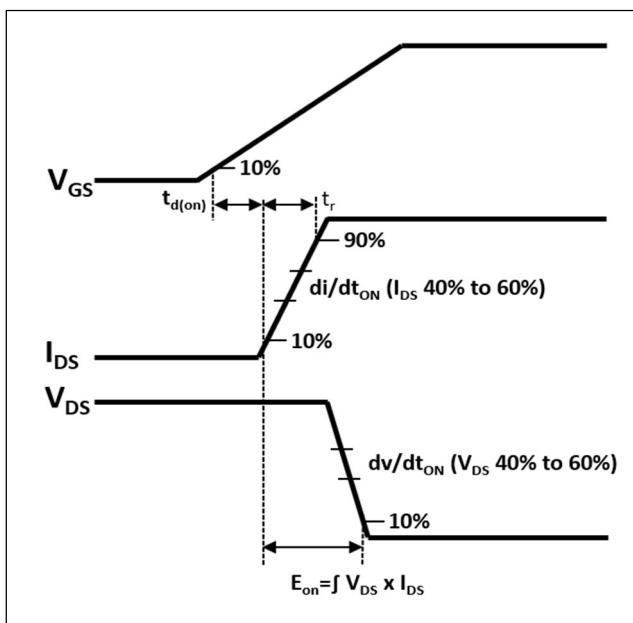
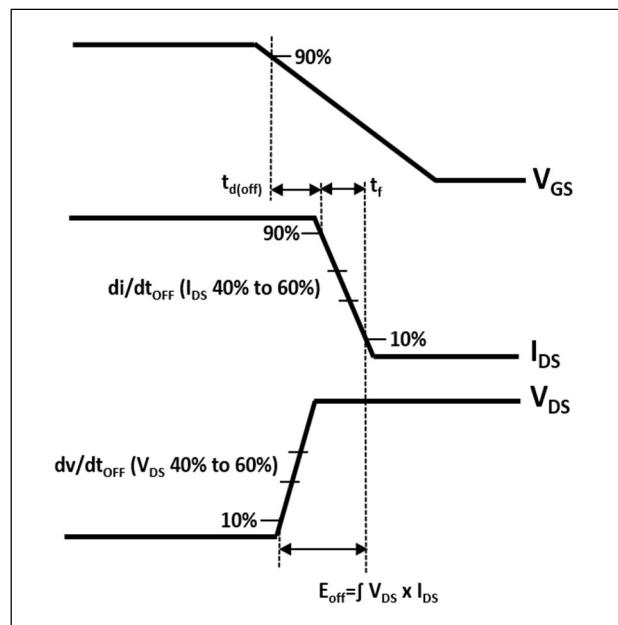
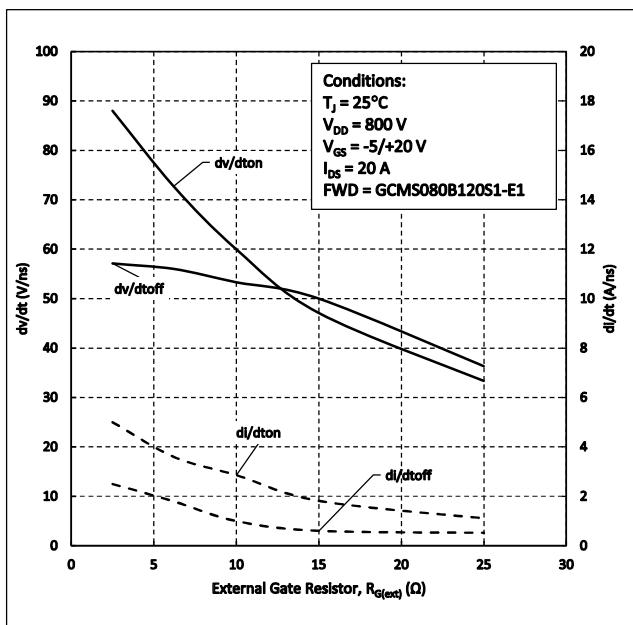


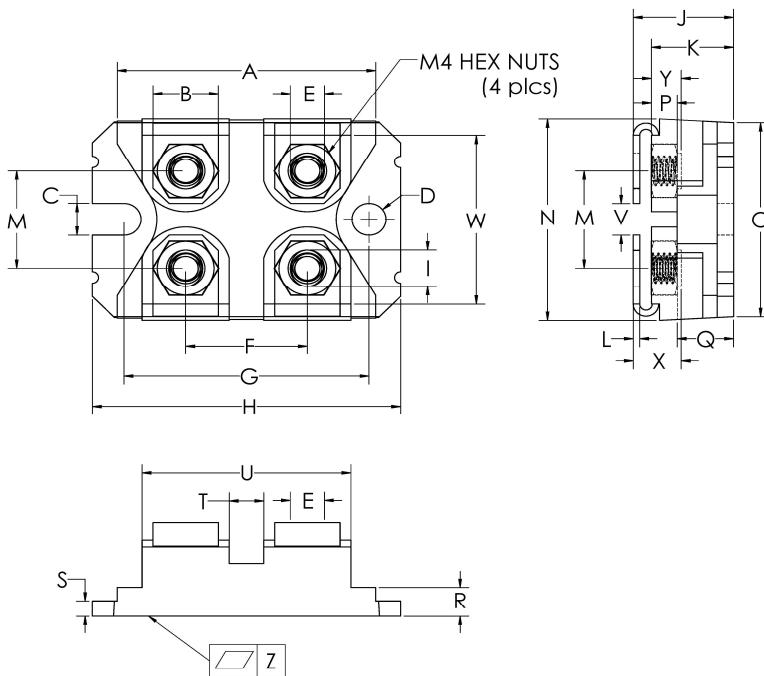
Figure 26. dv/dt and di/dt vs. Drain Current



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Package Dimensions SOT-227



Sym	Millimeters		Inches	
	Min	Max	Min	Max
A	31.67	31.90	1.247	1.256
B	7.95	8.18	0.313	0.322
C	4.14	4.24	0.163	0.167
D	4.14	4.24	0.163	0.167
E	4.14	4.24	0.163	0.167
F	14.94	15.09	0.588	0.594
G	30.15	30.25	1.187	1.191
H	38.00	38.10	1.496	1.500
I	4.75	4.83	0.187	0.190
J	11.68	12.19	0.460	0.480
K	9.45	9.60	0.372	0.378
L	0.76	0.84	0.030	0.033
M	12.62	12.88	0.497	0.507
N	25.15	25.30	0.990	0.996
O	24.79	25.04	0.976	0.986
P	3.02	3.15	0.119	0.124
Q	6.71	6.96	0.264	0.274
R	4.17	4.42	0.164	0.174
S	2.08	2.13	0.082	0.084
T	3.28	3.63	0.129	0.143
U	26.75	26.90	1.053	1.059
V	3.86	4.24	0.152	0.167
W	20.55	26.90	0.809	0.814
X	5.45	5.85	0.215	0.230
Y	3.15	3.66	0.124	0.144
Z	0.00	0.13	0.000	0.005

Revision History		
Date	Revision	Notes
2/19/2021	0.1	Preliminary release
10/15/2021	1.0	Initial release
12/3/2021	1.1	Fixed conditions typos

Notes

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.SemiQ.com.

REACH Compliance

REACH substances of high concern (SVHC) information is available for this product. Since the European Chemicals Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at SemiQ Headquarters in Lake Forest, California to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

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